

Functional Verification of CSI2 Rx-PHY using AMS Co-simulations

Ratheesh Mekkadan

Advanced Micro Devices, Inc.



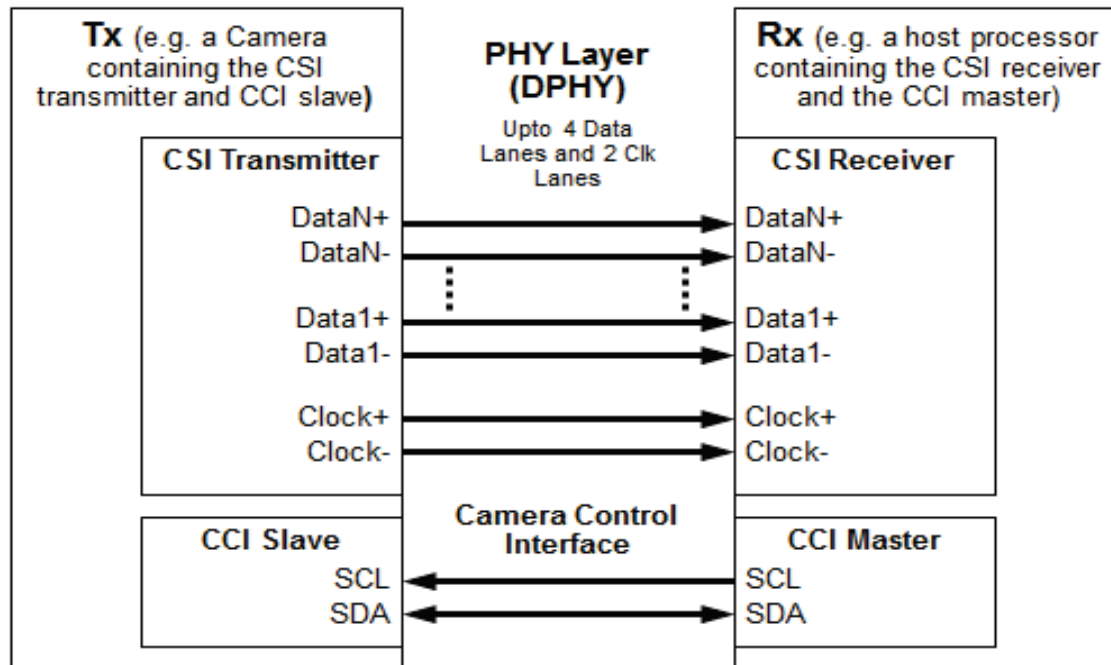
Agenda

- Introduction
- Scope of the Paper
- AMS Verification Approach
- Application and Results
- Conclusion
- Questions

Introduction

Introduction

- MIPI Camera Serial Interface 2 (CSI2) - standard interface between a peripheral device and host processor. Its Physical layer is the **MIPI DPHY**

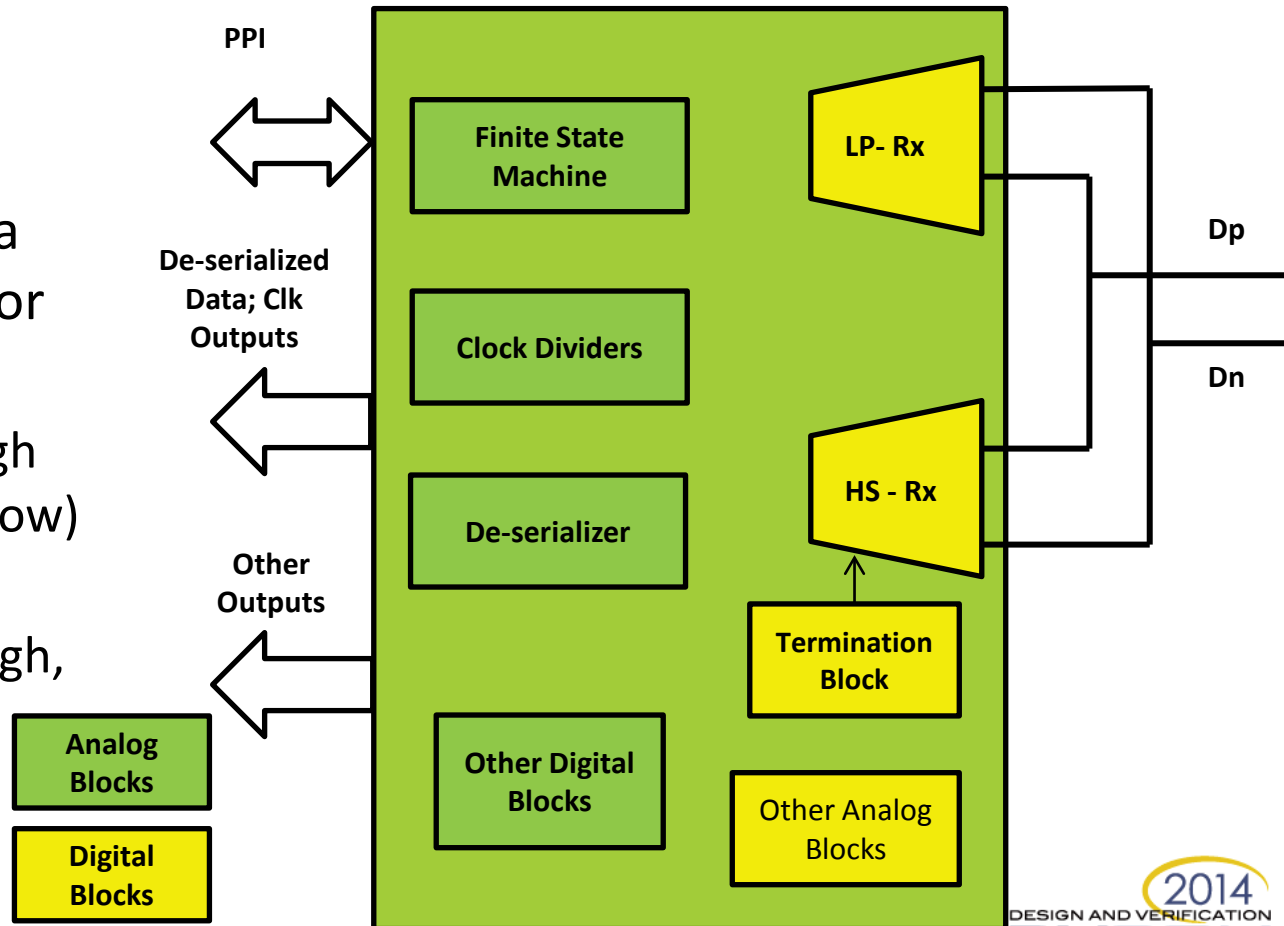


CSI2 PHY – An AMS IP

CSI2-PHY is an AMS IP

Supports HS mode data traffic and a LP mode for control sequencing

- LP -> Single Ended High Swing (1.2V high, 0V low)
- HS -> Differential Low Swing (e.g., 300mV high, 100mV low, 200mV common mode)



Operational Modes of CSI2 PHY

- DPHY **HS Mode** is used for data transfer in CSI2 protocol
- Data serialized in Tx PHY and de-serialized in Rx-PHY
- HS Mode sequencing seen for data transfer by Rx-PHY
 - LP-11 (StopState) → LP-01(HS-Request) → LP-00(HS- Prepare)
→ HS-0 → [HS Sync Pattern -- HS Payload Data -- HS Trailer] → LP-11 (StopState)
- During the HS Mode, the CSI2 PHY design enables line termination

Conventional RTL Verification Overview

- At IP/SoC simulations, RTL behavioral models are used for all analog blocks
- UVM based constrained random environment is used for verification.
 - Tb generates data bursts of random length and random data, error injection during start, payload or trail bits.
 - The UVM tb validates the mission mode and DFT functionality of the design.

Functional Verification Challenges

- RTL simulation environment is inadequate for verifying:
 - Functionality of the LP-Rx and the HS-Rx blocks
 - **LP and HS line voltage levels are different, but indistinguishable in a digital simulation.**
 - **Dynamic switching of voltages when transitioning LP \Leftrightarrow HS modes**
 - HS line termination
 - Analog functionality not modeled in the RTL behavioral model of the analog block

Scope of the Paper

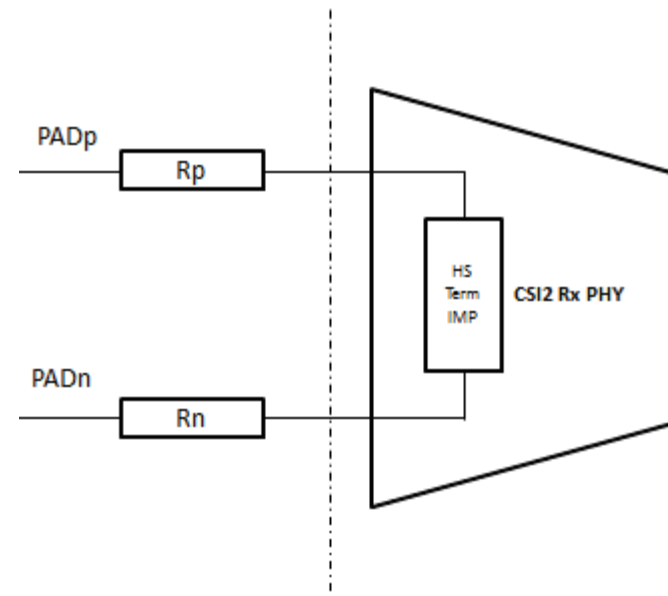
Scope of the Paper

- Focus is on overcoming the challenges in conventional RTL verification of CSI2 Rx PHY
- The paper discusses:
 - How an Analog Mixed Signal (co-simulation) approach can be used
 - Additional scenarios can be covered using the cosim environment for functional verification of the CSI2 Rx PHY

AMS Verification Approach

AMS Verification Approach (1/3)

- Setup:
 - Top layer is the UVM testbench
 - Tool used: XA-VCS tool from Synopsys
- Key highlights of the setup:
 - a) Analog and digital block partitioning for co-simulations
 - b) Signal source impedance



AMS Verification Approach (2/3)

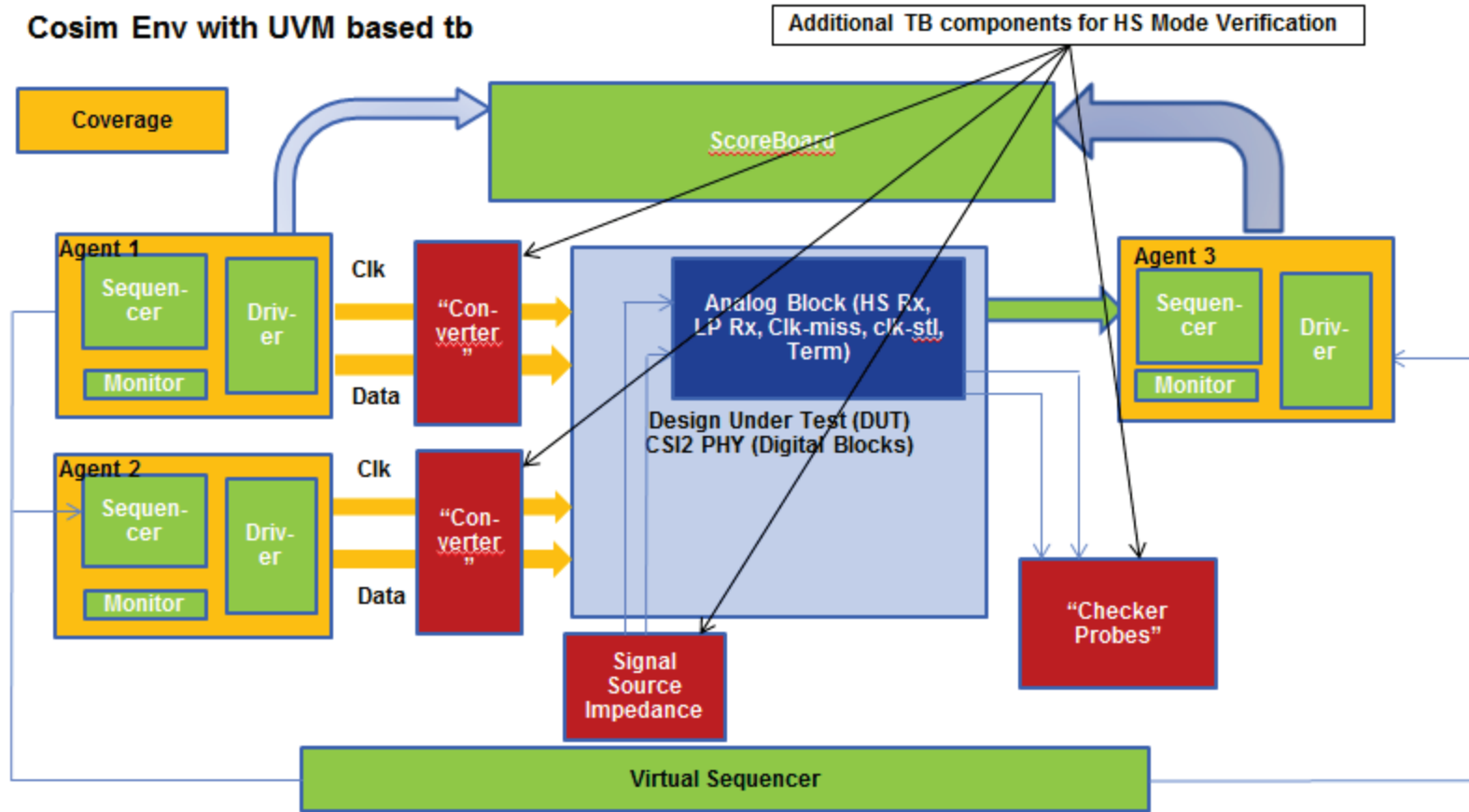
- Key highlights of the setup:
 - c) Converter block - LP and HS line voltage levels are different, and dynamic switching of voltages occurs when transitioning LP \Leftrightarrow HS

Normal d2a commands (from co-simulation tool) will not work here

Pseudo code:

```
always@(tb.hs_mode_en or tb.pad_csi_dl_p) begin
    if(tb.hs_mode_en==1 && tb.pad_csi_dl_p==1)
        $snps_force_volt (<hierarchy>.PADPp, <hs_hi_voltage>);
    else if(tb.hs_mode_en==1 && tb.pad_csi_dl_p==0)
        $snps_force_volt (<hierarchy>.PADPp, <hs_low_voltage>);
    else if(tb.hs_mode_en==0 && tb.pad_csi_dl_p==1)
        $snps_force_volt (<hierarchy>.vpadp, <lp_hi_voltage>);
    else if(tb.hs_mode_en==0 && tb.pad_csi_dl_p==0)
        $snps_force_volt (<hierarchy>.vpadp, <lp_low_voltage>);
end
```

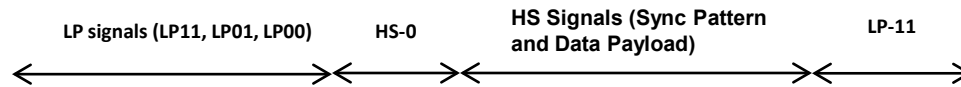
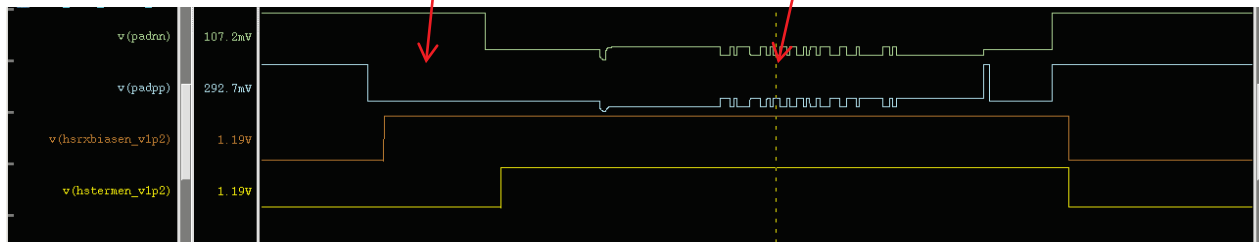
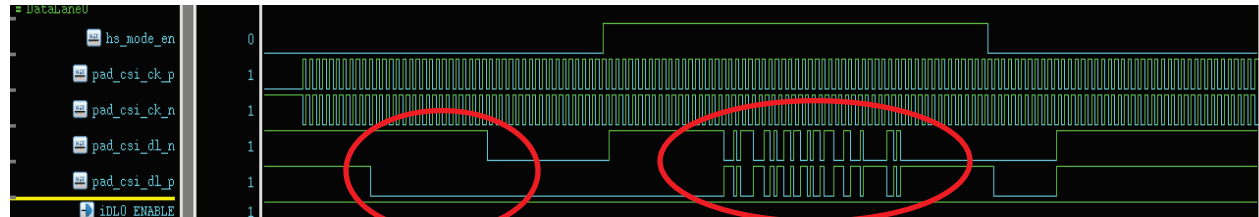
AMS Verification Approach (3/3)



Application and Results

Application and Results (1/4)

- a) LP Rx and HS Rx functionality validated for “data transfer” mode (which uses LP to HS sequencing)



Application and Results (2/4)

- b) Ensured valid voltage levels (per DPHY standard) are recognized by LP-Rx / HS-Rx by randomly varying voltage driven by “converter block”

Pseudo code

```
real lp_hi_int_v, lp_hi_frac_v, lp_hi_v;  
real lp_low_int_v, lp_low_frac_v, lp_low_v;  
lp_hi_int_v = $urandom_range(<LP_1_max>, <LP_1_min>);  
lp_hi_frac_v = $urandom_range(999, 1) / 1000;  
lp_hi_v = lp_hi_int_v + lp_hi_frac_v;  
  
lp_low_int_v = $urandom_range(<LP_0_max>, <LP_0_min>);  
lp_low_frac_v = $urandom_range(999, 1) / 1000;  
lp_low_v = lp_low_int_v + lp_low_frac_v;
```

Application and Results (3/4)

c) CSR configuration of HS termination block

Pseudo code

- a) Rx-PHY is powered-up and HS-Mode enabled
- b) Fixed (HS differential level) voltages driven on PADs
- c) Iterated through different settings for HS-termination

```
//thermometer coding; valid codes are 0,1,3,7,15,31,63,127
for (int i=0; i<8; i++) begin
    Term_CSR[6:0]={ Term_CSR [5:0], 1'b1};
end
```

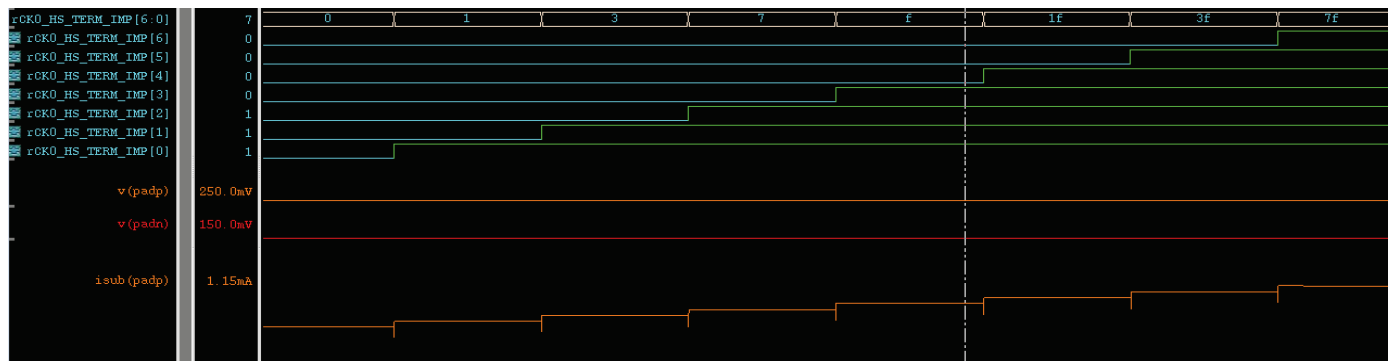
- d) In each case, measure PAD voltage and PAD current and determine the termination resistance

```
always@(<tb_signal_for_CSR_Term_cfg_done>) begin
    if(Core_dft_pwr_intf.iPWRGD_PWROK===1'b1) begin
        #<delay_value>;
        voltage_padp    = $snps_get_volt(<hierarchy>.PADP);
        voltage_padn    = $snps_get_volt(<hierarchy>.PADN);
        current_padp    = $snps_get_port_current(<hierarchy>.PADP);
        term_impedance  = (voltage_padp - voltage_padn) / current_padp;
    end
end
```

Application and Results (3/4)

Sample log file and waveform dump

```
UVM_INFO at 6015971: HS_TERM_IMP = 0, PADp(V) = 0.250000, PADn(V) = 0.150000,
PADp current = 0.000884 :: Term-impedance = 113.066436
UVM_INFO at 6916491: HS_TERM_IMP = 1, PADp(V) = 0.250000, PADn(V) = 0.150000,
PADp current = 0.000981 :: Term-impedance = 101.906082
UVM_INFO at 7817011: HS_TERM_IMP = 11, PADp(V) = 0.250000, PADn(V) =
0.150000, PADp current = 0.001067 :: Term-impedance = 93.686777
UVM_INFO at 8717531: HS_TERM_IMP = 111, PADp(V) = 0.250000, PADn(V) =
0.150000, PADp current = 0.001151 :: Term-impedance = 86.908291
...
```



Waveform plot showing the PAD voltage, CSR term_imp configuration, and PADp current draw

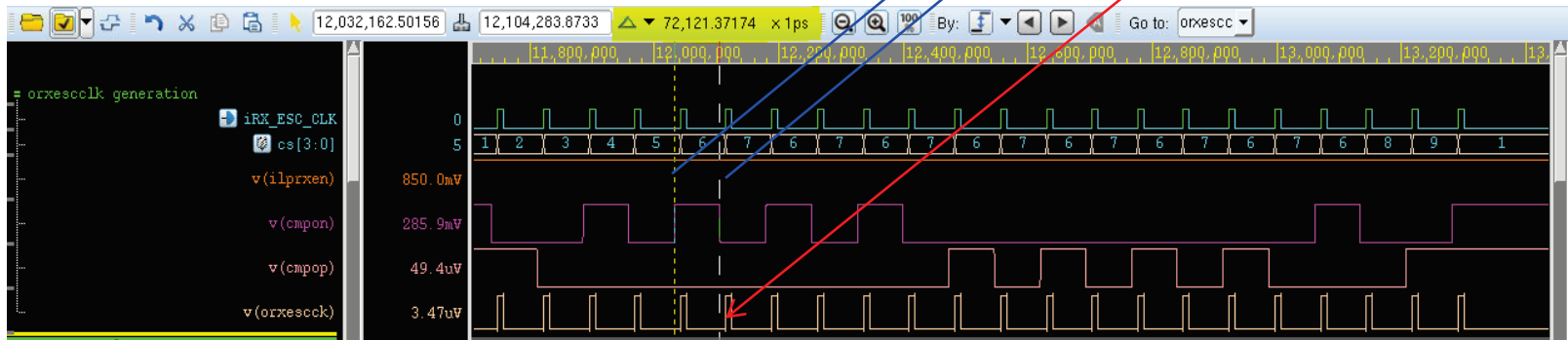
Results from Simulations (4/4)

- d) Validated proper design response to corner case scenarios
 - For data bursts of different lengths and random payload data. The design was also validated to respond to error induced into bit sequences.
 - Range of valid “data rates” supported by the DPHY standard for HS-Mode data transmission.
 - Pulse width requirement: LP-Mode bit pattern validated was by varying the pulse width in the digital UVM testbench.
 - Signal timing within the analog blocks (“clk-settle” time, as well as the “clk-miss” time parameters)

Key Issues Found

PHY unable to recover if Lane Enable glitches

LP state pulse width of 72ns generates EscClk



LaneEn glitch causes LP pulse width of 2ns. **NO EscClk**

FSM resets to 0, but stuck there due to **missing EscClk**



Key Issues Found

Correlating RTL simulation and co-simulation results identified inaccuracies in RTL model of analog blocks in the modelling “clk-settle” and “clk-miss” parameters.

Conclusion

Advantages of the Co-simulation Setup

- a) The UVM tb was effectively reused in cosim environment. Camera side stimulus, ScoreBoard checking and other protocol checks were reused as is.
- b) Validated LP-Rx and HS-Rx functionality by simulating the transition between LP Mode → HS Mode → LP Mode.
- c) Co-simulations are faster than full spice simulations. A full co-simulation run completes in 4 hours.
 - This enabled re-running a large number of tests that covered various random scenarios in the UVM tb, in the co-sim world.

Advantages of the Co-simulation Setup

- e) Automatic checking/monitoring of 'clk-miss' and 'clk-stl' DPHY parameters with the help of the "checker probes".
- f) Automatic checking of termination resistance calibration in the digital UVM testbench and indicating pass / fail criterion.

Questions

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